

GB02SLT12-214

Silicon Carbide Power Schottky Diode

 V_{RRM} = 1200 V $I_{F (Tc = 25^{\circ}C)}$ = 5 A $I_{F (Tc = 150^{\circ}C)}$ = 2 A Q_{C} = 9 nC

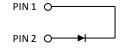
Features

- Industry's leading low leakage currents
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of V_F
- · Extremely fast switching speeds
- Superior figure of merit Q_C/I_F

Package

RoHS Compliant





DO - 214AA

Advantages

- Low standby power losses
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- · Ease of paralleling devices without thermal runaway
- · Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- · High Voltage Multipliers

Maximum Ratings at $T_j = 175$ °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}		1200	V	
Continuous forward current	l _F	T _C = 25 °C	5	Α	
Continuous forward current	l _F	T _C ≤ 150 °C	2	Α	
RMS forward current	I _{F(RMS)}	T _C ≤ 150 °C	3	Α	
Surge non-repetitive forward current, Half Sine	I _{F,SM}	$T_C = 25 ^{\circ}\text{C}, t_P = 10 \text{ms}$	18		
Wave		$T_C = 150 ^{\circ}\text{C}, t_P = 10 \text{ms}$	15	А	
Non-repetitive peak forward current	$I_{F,max}$	$T_C = 25 ^{\circ}\text{C}, t_P = 10 \mu\text{s}$	100	А	
l ² t value	∫i² dt	$T_C = 25 ^{\circ}\text{C}, t_P = 10 \text{ms}$	1.6	A^2s	
i i value		$T_C = 150 ^{\circ}\text{C}, t_P = 10 \text{ms}$	1.1		
Power dissipation	P _{tot}	T _C = 25 °C	65	W	
Operating and storage temperature	T_{j} , T_{stg}		-55 to 175	°C	

Electrical Characteristics at T_j = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions min.		Values		Unit	
Farameter	Зушьог			min.	typ.	max.	Unit
Diode forward voltage	V _F	I _F = 2 A, T _j = 25 °C		1.5	1.8	V	
Diode forward voltage	٧F	$I_F = 2 \text{ A}, T_j = 175 ^{\circ}\text{C}$			2.6	3.0	V
Reverse current	1	V _R = 1200 V, T _j = 25 °C		5	50	μA	
	I _R	$V_R = 1200 \text{ V}, T_j = 175 ^{\circ}\text{C}$			10		100
Total capacitive charge	0		V _R = 400 V		9 14		nC
	Q_{c}		$V_R = 960 \text{ V}$				IIC
Switching time		dI _F /dt = 200 A/μs T _i = 175 °C	V _R = 400 V		< 17	no	
	t _s	$V_R = 960$			< 17		ns
		$V_R = 1 \text{ V, f} = 1 \text{ MHz, T}_j = 25 \text{ °C}$		131			
Total capacitance	С	$V_R = 400 \text{ V}, f = 1 \text{ MHz}, T_j = 25 \text{ °C}$			12		pF
		$V_R = 1000 \text{ V}, f = 1 \text{ MHz}, T_j = 25 \text{ °C}$		8			

Thermal Characteristics

Thermal resistance, junction - case	R _{thJC}	2.3	°C/W



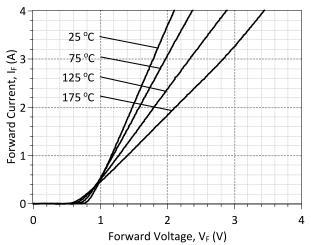


Figure 1: Typical Forward Characteristics

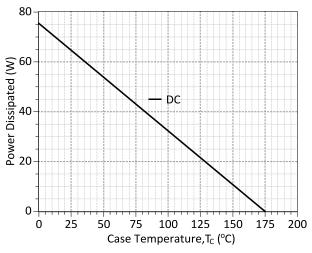


Figure 3: Power Derating Curve

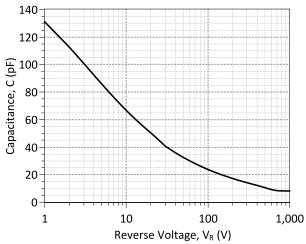


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

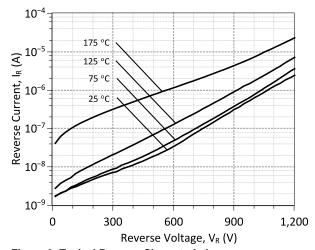


Figure 2: Typical Reverse Characteristics

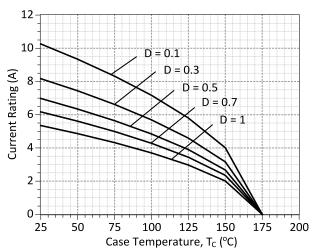


Figure 4: Current Derating Curves (D = t_P/T , t_P = 400 µs) (Considering worst case Z_{th} conditions)

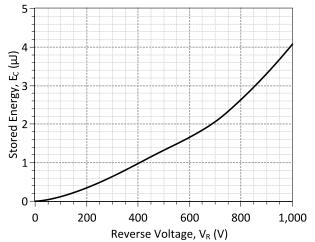


Figure 6: Typical Capacitive Energy vs Reverse Voltage Characteristics





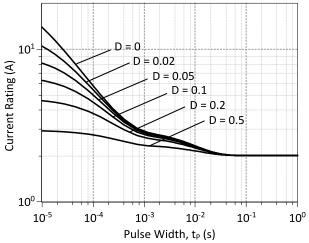


Figure 7: Current vs Pulse Duration Curves at T_C = 160 °C

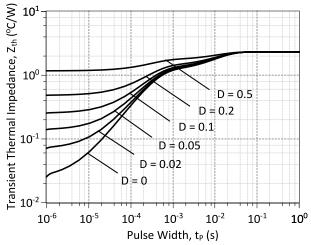
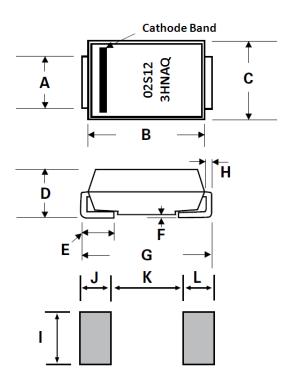


Figure 8: Transient Thermal Impedance

Package Dimensions:

DO-214AA

PACKAGE OUTLINE



Inc	hes	Millimeters		
Min	Max	Min	Max	
0.077	0.086	1.950	2.200	
0.160	0.180	4.060	4.570	
0.130	0.155	3.300	3.940	
0.084	0.096	2.130	2.440	
0.030	0.060	0.760	1.520	
-	0.008	-	0.203	
0.205	0.220	5.210	5.590	
0.006	0.012	0.152	0.305	
0.089	-	2.260	-	
0.085	-	2.160	-	
-	0.107	-	2.740	
0.085	-	2.160	-	
	Min 0.077 0.160 0.130 0.084 0.030 - 0.205 0.006 0.089 0.085	Min Max 0.077 0.086 0.160 0.180 0.130 0.155 0.084 0.096 0.030 0.060 - 0.008 0.205 0.220 0.006 0.012 0.089 - 0.085 - 0.107	Min Max Min 0.077 0.086 1.950 0.160 0.180 4.060 0.130 0.155 3.300 0.084 0.096 2.130 0.030 0.060 0.760 - 0.008 - 0.205 0.220 5.210 0.006 0.012 0.152 0.089 - 2.260 0.085 - 2.160 - 0.107 -	

NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



Revision History					
Date	Revision	Comments	Supersedes		
2014/08/26	1	Updated Electrical Characteristics			
2013/09/09	0	Initial release			

Published by GeneSiC Semiconductor, Inc. 43670 Trade Center Place Suite 155 Dulles, VA 20166

GeneSiC Semiconductor, Inc. reserves right to make changes to the product specifications and data in this document without notice.

GeneSiC disclaims all and any warranty and liability arising out of use or application of any product. No license, express or implied to any intellectual property rights is granted by this document.

Unless otherwise expressly indicated, GeneSiC products are not designed, tested or authorized for use in life-saving, medical, aircraft navigation, communication, air traffic control and weapons systems, nor in applications where their failure may result in death, personal injury and/or property damage.



SPICE Model Parameters

This is a secure document. Please copy this code from the SPICE model PDF file on our website (http://www.genesicsemi.com/images/products_sic/rectifiers/GB02SLT12-214_SPICE.pdf) into LTSPICE (version 4) software for simulation of the GB02SLT12-214.

```
MODEL OF GeneSiC Semiconductor Inc.
     $Revision: 1.0
     $Date: 09-SEP-2013
                                 $
     GeneSiC Semiconductor Inc.
     43670 Trade Center Place Ste. 155
     Dulles, VA 20166
     COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
     ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
 Models accurate up to 2 times rated drain current.
* Start of GB02SLT12-214 SPICE Model
.SUBCKT GB02SLT12 ANODE KATHODE
D1 ANODE KATHODE GB02SLT12
D2 ANODE KATHODE GB02SLT12 PIN
.MODEL GB02SLT12 D
+ IS
       2.05E-15
                                      0.282
                           RS
+ TRS1
          0.0054
                           TRS2
                                      3E-05
                           IKF
                                      251
+ N
          1
+ EG
          1.2
                           XTI
                                      -1.8
+ CJO
          1.61E-10
                           VJ
                                      0.4508
+ M
          1.586
                           FC
                                      0.5
          1.00E-10
+ TT
                           BV
                                      1200
+ IBV
          1.00E-03
                           VPK
                                      1200
+ IAVE
                           TYPE
                                      SiC Schottky
       GeneSiC Semi
+ MFG
.MODEL GB02SLT12 PIN D
+ IS
       1.54E-25
                                      0.39
                           RS
+ TRS1
          -0.003
                           Ν
                                      3.941
           3.23
+ EG
                           IKF
                                      19
          0
+ XTI
                           FC
                                      0.5
+ TT
                                      1200
                           BV
          1.00E-03
+ IBV
                           VPK
                                      1200
+ IAVE
          10
                           TYPE
                                      SiC PiN
.ENDS
```

* End of GB02SLT12-214 SPICE Model